

PATENT ASSIGNMENT

Electronic Version v1.1
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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Triloka Chander Tankala</td> <td>05/25/2012</td> </tr> <tr> <td>Venkatesha Narayanaswamy</td> <td>05/29/2012</td> </tr> <tr> <td>Arunachala Parameshwara</td> <td>05/25/2012</td> </tr> <tr> <td>Poovanna Theethira Kushalappa</td> <td>05/25/2012</td> </tr> <tr> <td>Seongnam Kang</td> <td>07/27/2012</td> </tr> </tbody> </table>		Name	Execution Date	Triloka Chander Tankala	05/25/2012	Venkatesha Narayanaswamy	05/29/2012	Arunachala Parameshwara	05/25/2012	Poovanna Theethira Kushalappa	05/25/2012	Seongnam Kang	07/27/2012
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RECEIVING PARTY DATA													
<table border="1"> <tr> <td>Name:</td> <td>SABIC Innovative Plastics IP B.V.</td> </tr> <tr> <td>Street Address:</td> <td>Plasticslaan 1</td> </tr> <tr> <td>City:</td> <td>Bergen op Zoom</td> </tr> <tr> <td>State/Country:</td> <td>NETHERLANDS</td> </tr> <tr> <td>Postal Code:</td> <td>4612 PX</td> </tr> </table>		Name:	SABIC Innovative Plastics IP B.V.	Street Address:	Plasticslaan 1	City:	Bergen op Zoom	State/Country:	NETHERLANDS	Postal Code:	4612 PX		
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Application Number:	13483555												
CORRESPONDENCE DATA													
<p>Fax Number: 8602860115 Phone: 860-286-2929 Email: hgrady@cantorcolburn.com <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i></p> <p>Correspondent Name: Cantor Colburn LLP Address Line 1: 20 Church Street Address Line 2: 22nd Floor Address Line 4: Hartford, CONNECTICUT 06103</p>													
ATTORNEY DOCKET NUMBER:	P080073US2												
NAME OF SUBMITTER:	Pamela J. Curbelo												

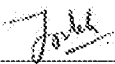
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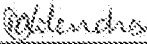
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ASSIGNMENT

For valuable consideration, the receipt and adequacy of which is hereby acknowledged and in fulfillment of our pre-existing obligation of assignment, I/we **Triloka Chander Tankala** residing in Chennai, India having a mailing address at AG-1, Sri Harshita Apartments, 2nd cross street, laxman road, cbi colony, kandhanchavadi, Chennai, 600096, India; Venkatesha Narayanaswamy residing in Bangalore, India having a mailing address at John F Welch Technology Centre Export Promotion Industrial Park, Phase 2 Hoodi Village, Whitefield Road, Bangalore, Karnataka 560066, India; Arunachala Parameshwara residing in Bangalore, India having a mailing address at John F Welch Technology Centre Export Promotion Industrial Park, Phase 2 Hoodi Village, Whitefield Road, Bangalore, Karnataka 560066, India; Poovanna Theethira Kushalappa residing in Bangalore, India having a mailing address at John F Welch Technology Centre Export Promotion Industrial Park, Phase 2 Hoodi Village, Whitefield Road, Bangalore, Karnataka 560066, India; and Seongnam Kang residing in Sungnam City, Korea, sell and assign to SABIC Innovative Plastics IP B.V., a corporation organized and existing under the laws of The Netherlands, having an address at Plasticlaan 1, 4612 PX Bergen op Zoom, The Netherlands, its successors and assigns the entire right, title and interest in and to U.S. Application Serial No. 61/491,546, filed May 31, 2011, and to the improvements in "LED PLASTIC HEAT SINK AND METHOD FOR MAKING AND USING THE SAME" invented by me/us, and any and all applications for patent and patents therefore in any and all countries, including all divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of any previously filed patent application with the same or similar subject matter, and authorize and request any official whose duty it is to issue patents, to issue any patent on said improvements or resulting therefrom to said SABIC Innovative Plastics IP B.V. or its successors or assigns and agree that on request and without further consideration, but at the expense of said SABIC Innovative Plastics IP B.V., I/we will communicate to said SABIC Innovative Plastics IP B.V. or its representatives or nominees any facts known to us respecting said improvements and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said Company, its successors, assigns, and nominees to obtain and enforce proper patent protection for said improvements in all countries.

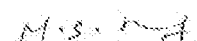
1. 
Triloka Chander Tankala

Date: 25/5/2012

Witnessed by: 
Signature

Date: 25/5/2012

SATEENDRA MEDURI
Printed Name of Witness

Witnessed by: 
Signature

Date: 25/5/2012

M.S. RAJESH
Printed Name of Witness

2. _____
Venkatesha Narayanaswamy

Date: _____

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

3. _____
Arunachala Parameshwara

Date: _____

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

4. _____
Poovanna Theethira Kushalappa

Date: _____

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

5. _____
Seongnam Kang

Date: _____

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

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1. _____
Triloka Chander Tankala

Date: _____

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

2.

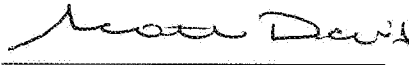


Venkatesha Narayanaswamy

Date:

May 29th, 2012

Witnessed by:



Signature

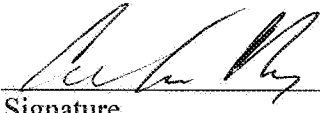
Date:

MAY 29, 2012

SCOTT DAVIS

Printed Name of Witness

Witnessed by:



Signature

Date:

May 29, 2012

Andrew May

Printed Name of Witness

3.

Arunachala Parameshwara

Date: _____

Witnessed by:

Signature

Date: _____

Printed Name of Witness

Witnessed by:

Signature

Date: _____

Printed Name of Witness

4. _____
Poovanna Theethira Kushalappa

Date: _____

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

5. _____
Seongnam Kang

Date: _____

Witnessed by: _____
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Triloka Chander Tankala

Date: _____

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

10PLAS0059-US-NP
(P080073US2)

2. Venkatesha Narayanaswamy

Date: _____

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

3. Arunachala Parameshwara

Date: 25th MAY 2012

Witnessed by: D. Prasad
Signature

Date: 25th May, 2012

PRASAD DASAPPA
Printed Name of Witness

Witnessed by: [Signature]
Signature

Date: 25/05/2012

YUGANDHARA SINGH
Printed Name of Witness

4. _____
Poovanna Theethira Kushalappa

Date: _____

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

5. _____
Seongnam Kang

Date: _____

Witnessed by: _____
Signature

Date: _____

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1. _____
Triloka Chander Tankala

Date: _____

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

2. _____
Venkatesha Narayanaswamy

Date: _____

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

3. _____
Arunachala Parameshwara

Date: _____

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Signature

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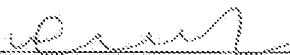
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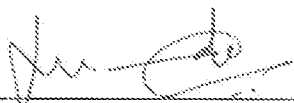
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Poovanna Theethira Kushalappa

Date: 25 MAY 2012

Witnessed by: Srikant S Padhee
Signature

Date: 25th May 2012

SRIKANT SRIKANT PADHEE
Printed Name of Witness

Witnessed by: 
Signature

Date: 25th MAY 2012

B.V. SOMASEKHAR
Printed Name of Witness

5. _____
Seongnam Kang

Date: _____

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

Witnessed by: _____
Signature

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Printed Name of Witness

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1. _____ Date: _____
Triloka Chander Tankala

Witnessed by: _____ Date: _____
Signature

Printed Name of Witness

Witnessed by: _____ Date: _____
Signature

Printed Name of Witness

2. _____
Venkatesha Narayanaswamy

Date: _____

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

3. _____
Arunachala Parameshwara

Date: _____

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

4. _____
Poovanna Theethira Kushalappa

Date: _____

Witnessed by: _____
Signature

Date: _____

Printed Name of Witness

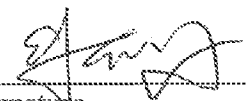
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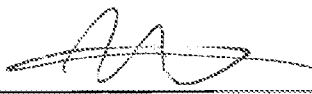
5. 
Seongnam Kang

Date: 2012. 7. 27

Witnessed by: 
Signature

Date: 2012. 7. 27

Taejeop Yoon
Printed Name of Witness

Witnessed by: 
Signature

Date: 2012. 7. 27

Eunghul Kim
Printed Name of Witness